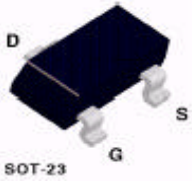
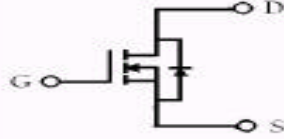


NPN CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

2N7002



Equivalent Circuit



G : Gate
S : Source
D : Drain

PIN COFIGURATION

G= GATE
S= SOURCE
D= DRAIN

SOT-23
Formed SMD Package

Marking

2N7002=S72

Designed for High Speed Pulse Amplifier and Drive Application

ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless specified otherwise)

DESCRIPTION	SYMBOL	VALUE	UNITS
Drain Source Voltage	V_{DSS}	60	V
Drain Gate Voltage	V_{DRG}	60	V
Gate Source Voltage	V_{GSS}	20	V
Maximum Drain Current Continuous	I_D	200	mA
Maximum Drain Current Pulse	$*I_D$	800	mA
Maxium Power Dissipation Derating Above 25°C	P_D	350	mW
Operating and Storage Junction Temperature Range	T_j, T_{stg}	- 55 to +150	°C

THERMAL RESISTANCE

Junction to Ambient in free air	$R_{th(j-a)}$	357	°C/W
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ELECTRICAL CHARACTERISTICS ($T_a=25^\circ\text{C}$ unless specified otherwise)

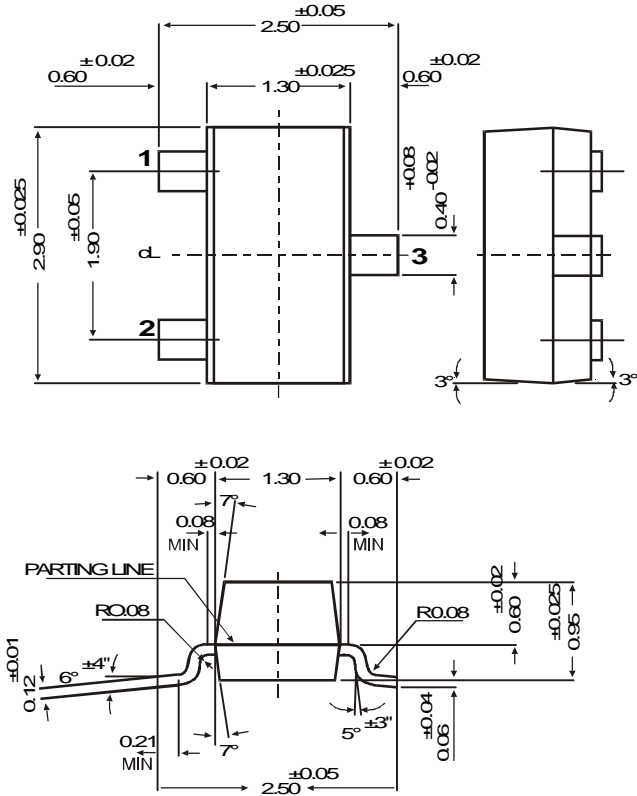
DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Drain Source Breakdown Voltage	V_{DSS}	$V_{GS}=0V, I_D=10\mu A$	60			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=60V, V_{GS}=0$ $V_{DS}=60V, V_{GS}=0, T_j=125^\circ\text{C}$			1.0 0.5	μA mA
Gate Body Leakage Forward	I_{GSSF}	$V_{DS}=0, V_{GS}=20V$			100	nA
Gate Body Leakage Reverse	I_{GSSR}	$V_{DS}=0, V_{GS}= -20V$			- 100	nA
Gate Threshold Voltage	$*V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0		2.5	V
Static Drain Source On Resistance	$*R_{DS(on)}$	$V_{GS}=10V, I_D=500mA$			7.5	Ω
Drain Source On Voltage	$*V_{DS(on)}$	$V_{GS}=10V, I_D=500mA$ $V_{GS}=5V, I_D=50mA$			3.75 1.5	V
On State Drain Current	$*I_{D(on)}$	$V_{GS}=10V, V_{DS} \geq 2V_{DS(on)}$	500			mA
Forward Transconductance	$*G_{FS}$	$V_{GS} > 2V, V_{DS(on)}, I_D=200mA$	80			mS

DYNAMIC CHARACTERISTICS

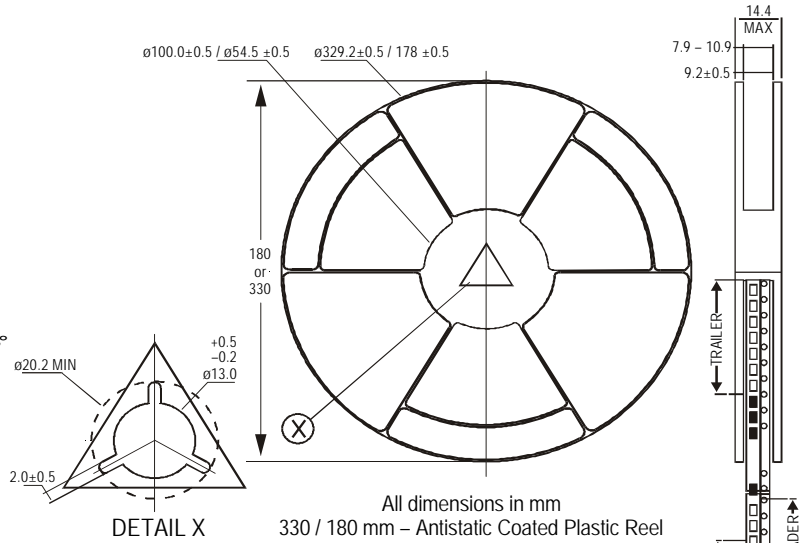
Input Capacitance	C_{ISS}	$V_{DS}=25V, V_{GS}=0V, f=1MHz$			50	pF
Output Capacitance	C_{OSS}				25	pF
Reverse Transfer Capacitance	C_{RSS}				5.0	pF
Turn On Time	t_{on}	$V_{DD}=30V, R_L=25\Omega,$ $I_D=500mA, V_{GS}=10V,$ $R_{GEN}=25\Omega$			20	ns
Turn Off Time	t_{off}				20	ns

*Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

SOT-23 Formed SMD Package



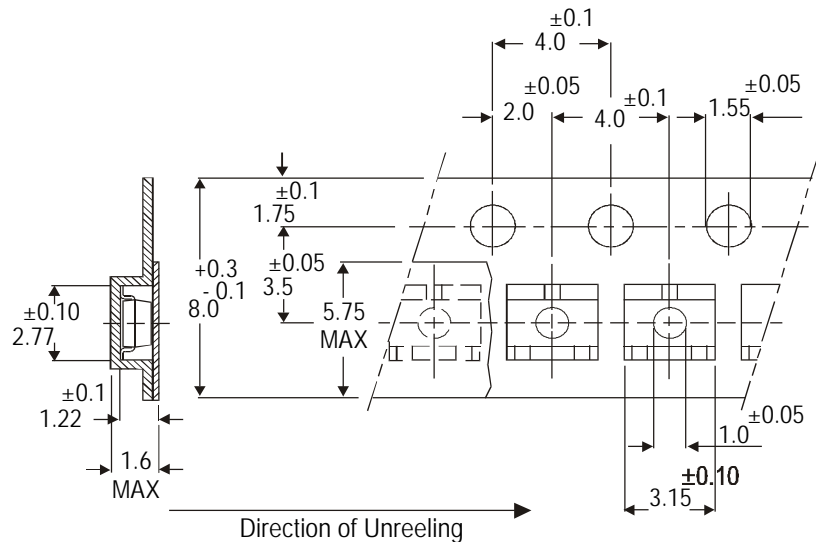
SOT-23 Package Reel Information
Reel Specifications for W Packing (13" and 7")



NOTES:

- The bandolier of 330 mm reel contains at least 10,000 devices.
- The bandolier of 180 mm reel contains at least 3,000 devices.
- No more than 0.5% missing devices / reel. 50 empty compartments for 330 mm reel. 15 empty compartments for 180 mm reel.
- Three consecutive empty places might be found provided this gap is followed by 6 consecutive devices.
- The carrier tape (leader) starts with at least 75 empty positions (equivalent to 330 mm). In order to fix the carrier tape a self adhesive tape of 20 to 50 mm is applied. At the end of the bandolier at least 40 empty positions (equivalent to 160 mm) are there.

Tape Specification for SOT-23 Surface Mount Device



Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
SOT-23 T&R	3K/feel	136 gm/3K pcs	3" x 7.5" x 7.5"	12 K	17" x 15" x 13.5"	192 K	12 kgs
	10K/feel	415 gm/10K pcs	9" x 9" x 9"	51 K	19" x 19" x 19"	408 K	28 kgs
			13" x 13" x 0.5"	10 K	17" x 15" x 13.5"	300 K	16 kgs

Disclaimer

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